

# DATA SHEET

**RC23H**

**0.5%**

High-precision chip resistors  
size 0603

Product specification  
Supersedes data of 2nd December 1999

2001 Apr 27 Rev.2

# High-precision chip resistors size 0603

# RC23H 0.5%

## FEATURES

- Reduced size of final equipment
- Low assembly costs
- Higher component and equipment reliability.

## APPLICATIONS

- Power supplies in small equipment
- Digital multimeters
- Telecommunication
- Computers
- Automotive industry
- Medical and military equipment.

## DESCRIPTION

The resistors are constructed on a high grade ceramic body (aluminium oxide). Internal metal electrodes are added at each end and connected by a resistive paste which is applied to the top surface of the substrate. The composition of the paste is adjusted to give the approximate resistance required and the value is trimmed to within tolerance, by laser cutting of this resistive layer.

The resistive layer is covered with a protective coating and printed with the resistance value. Finally, the two external end terminations are added. For ease of soldering the outer layer of these end terminations is a lead-tin alloy.

## QUICK REFERENCE DATA

DESCRIPTION	VALUE
Resistance range	100 $\Omega$ to 1 M $\Omega$ ; E24/E96 series
Resistance tolerance	$\pm 0.5\%$
Temperature coefficient:	$\leq \pm 100 \times 10^{-6}/K$
Absolute maximum dissipation at $T_{amb} = 70 \text{ }^{\circ}C$	0.063 W
Maximum permissible voltage	50 V (DC or RMS)
Climatic category (IEC 60068)	55/125/56
Basic specification	IEC 60115-8

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## ORDERING INFORMATION

**Table 1** Ordering code indicating resistor type and packing

TYPE	RESISTANCE RANGE	TOL. (%)	SERIES	ORDERING CODE 2350 546 .....
				CARDBOARD TAPE ON REEL
				5000 units
RC23H	100 $\Omega$ to 1 M $\Omega$	$\pm 0.5$	E24/E96	0....

### Ordering code (12NC)

- The resistors have a 12-digit ordering code starting with 2350 546; see Table 1.
- The subsequent digit indicates the resistor type and packing.
- The remaining digits indicate the resistance value:
  - The first 3 digits indicate the resistance value.
  - The last digit indicates the resistance decade in accordance with Table 2.

**Table 2** Last digit of 12NC

RESISTANCE DECADE	LAST DIGIT
100 to 976 $\Omega$	1
1 to 9.76 k $\Omega$	2
10 to 97.6 k $\Omega$	3
100 to 976 k $\Omega$	4
1 M $\Omega$	5

### ORDERING EXAMPLE

The ordering code of a RC23H resistor, value 4750  $\Omega$  with a tolerance of  $\pm 0.5\%$ , supplied on cardboard tape of 5000 units per reel is: 2350 546 04752.

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### FUNCTIONAL DESCRIPTION

#### Product characterization

Standard values of nominal resistance are taken from the E24/E96 series for resistors with a tolerance of  $\pm 0.5\%$ .

#### Limiting values

TYPE	LIMITING VOLTAGE <sup>(1)</sup> (V)	LIMITING POWER (W)
RC23H	50	0.063

#### Note

- The maximum voltage that may be continuously applied to the resistor element, see "IEC publication 60115-8".

### DERATING

The power that the resistor can dissipate depends on the operating temperature; see Fig.1.

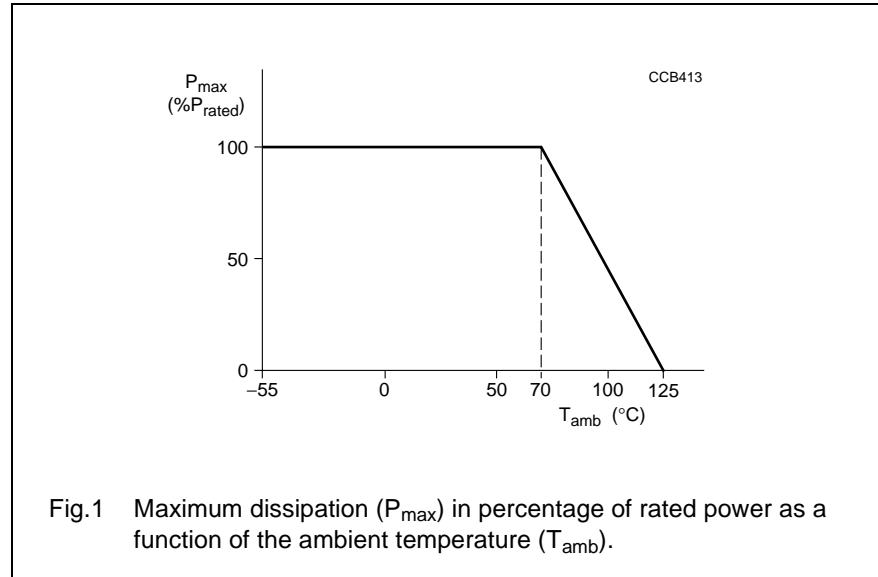


Fig.1 Maximum dissipation ( $P_{max}$ ) in percentage of rated power as a function of the ambient temperature ( $T_{amb}$ ).

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### MECHANICAL DATA

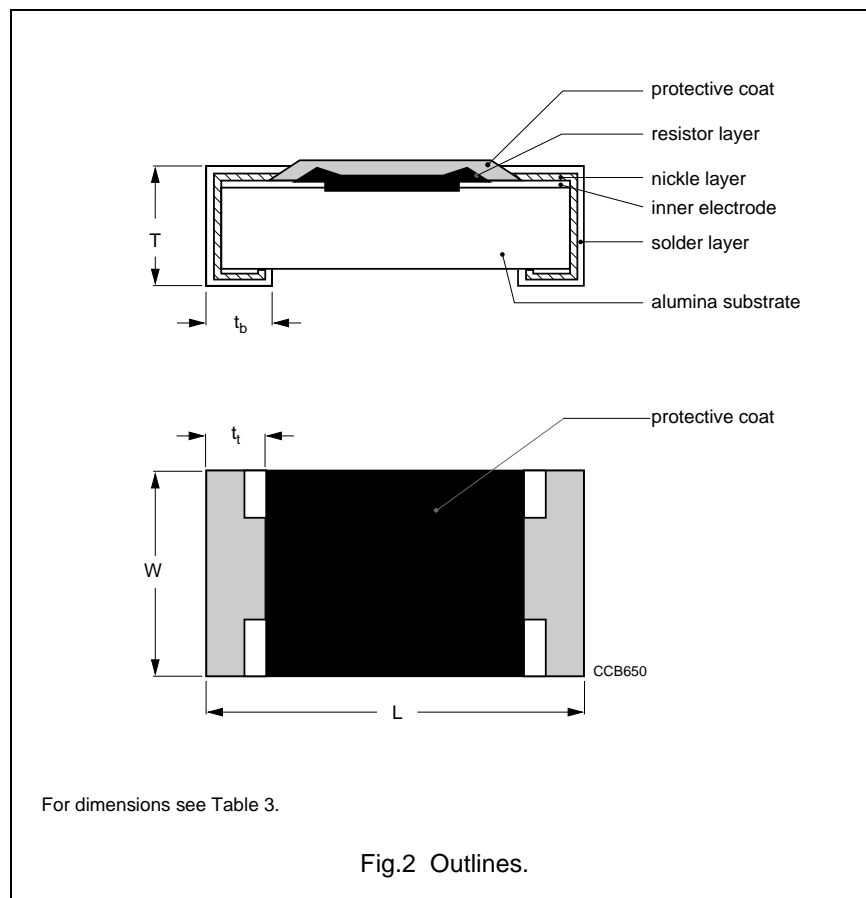
#### Mass per 100 units

TYPE	MASS (g)
RC23H	0.25

#### Marking

The resistor is not marked.  
The packing is marked and includes resistance value, tolerance, TC value, catalogue number, quantity, production period, batch number and source code.

### Outlines



**Table 3** Chip resistor type and relevant physical dimensions; see Fig.2

TYPE	L (mm)	W (mm)	T (mm)	t <sub>t</sub> (mm)	t <sub>b</sub> (mm)
RC23H	1.6 ±0.10	0.8 +0.15/-0.05	0.45 ±0.10	0.30 ±0.20	0.30 ±0.20

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### TESTS AND REQUIREMENTS

Essentially all tests are carried out in accordance with the schedule of "IEC publication 60115-8", category 55/125/56 (rated temperature range  $-55$  to  $+125$  °C; damp heat, long term, 56 days).

The testing also covers the requirements specified by EIA and EIAJ.

The tests are carried out in accordance with IEC publication 60068, "Recommended basic climatic and mechanical robustness testing procedure for electronic components" and under standard atmospheric conditions in accordance with "IEC 60068-1", subclause 5.3.

Unless otherwise specified the following values apply:

Temperature: 15 °C to 35 °C

Relative humidity: 45% to 75%

Air pressure: 86 kPa to 106 kPa  
(860 mbar to 1060 mbar).

In Table 4 the tests and requirements are listed with reference to the relevant clauses of "IEC publications 60115-8 and 60068", a short description of the test procedure is also given. In some instances deviations from the IEC recommendations were necessary for our method of specifying.

All soldering tests are performed with mildly activated flux.

**Table 4** Test procedures and requirements

IEC 60115-8 CLAUSE	IEC 60068-2 TEST METHOD	TEST	PROCEDURE	REQUIREMENTS
<b>Tests in accordance with the schedule of IEC publication 60115-8</b>				
4.4.1		visual examination		no holes; clean surface; no visible damage
4.5		resistance	applied voltage (0 to $-10\%$ ): $100 \Omega \leq R < 1 \text{ k}\Omega$ : 1 V $1 \text{ k}\Omega \leq R < 10 \text{ k}\Omega$ : 3 V $10 \text{ k}\Omega \leq R < 100 \text{ k}\Omega$ : 10 V $100 \text{ k}\Omega \leq R < 1 \text{ M}\Omega$ : 25 V $R = 1 \text{ M}\Omega$ : 50 V	$R - R_{\text{nom}}$ : max. $\pm 0.5\%$
4.17	20 (Ta)	solderability	unmounted chips completely immersed for $2 \pm 0.5$ s in a solder bath at $235 \pm 2$ °C	good tinning ( $\geq 95\%$ covered); no visible damage
4.18	20 (Tb)	resistance to soldering heat	unmounted chips; $10 \pm 1$ s; $260 \pm 5$ °C	no visible damage $\Delta R/R$ max.: $\pm(0.5\% + 0.05 \Omega)$
4.13		short time overload	room temperature; dissipation = $6.25 \times P_n$ ; 5 s (voltage not more than $2 \times V_{\text{max}}$ )	$\Delta R/R$ max.: $\pm(1\% + 0.05 \Omega)$
4.33		bending	resistors mounted on a 90 mm glass epoxy resin PCB (FR4), bending: 3 mm for 1206; 5 mm for 0805, 0603	no visible damage $\Delta R/R$ max.: $\pm(0.5\% + 0.05 \Omega)$
4.19	14 (Na)	rapid change of temperature	30 minutes at LCT and 30 minutes at UCT; 5 cycles	no visible damage $\Delta R/R$ max.: $\pm(0.5\% + 0.05 \Omega)$
4.6.1.1		insulation resistance	voltage (DC) after 1 minute, metal block method; 100 V	$R_{\text{ins}}$ min.: 1000 M $\Omega$
4.24.2	3 (Ca)	damp heat (steady state)	56 days; $40 \pm 2$ °C; 93 $\pm 2/-3\%$ RH; loaded with $0.01 P_n$ : $R \leq 1 \text{ M}\Omega$	$\Delta R/R$ max.: $\pm(1.0\% + 0.05 \Omega)$

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IEC 60115-8 CLAUSE	IEC 60068-2 TEST METHOD	TEST	PROCEDURE	REQUIREMENTS
4.25.1		endurance	1000 +48/-0 hours; 70 ±2 °C; loaded with P <sub>n</sub> or V <sub>max</sub> ; 1.5 hours on, 0.5 hour off: R ≤ 1 MΩ	ΔR/R max.: ±(1.0% + 0.05 Ω)
4.25.1		endurance at upper category temperature	1000 +48/-0 hours, no load: R ≤ 1 MΩ	ΔR/R max.: ±(1.0% + 0.05 Ω)
4.8.4.2		temperature coefficient	at 20/LCT/20 °C and 20/UCT/20 °C	ΔR/R max.: ±100 × 10 <sup>-6</sup> /K
<b>Other tests in accordance with IEC 60115 clauses and IEC 60068 test method</b>				
4.17	20 (Ta)	solderability (after ageing)	8 hours steam or 16 hours at 155 °C; unmounted chips completely immersed for 2 ±0.5 s in a solder bath at 235 ±2 °C	good tinning (≥95% covered); no visible damage
4.12		noise	IEC publication 60195 (measured with Quantech-equipment): 100 Ω < R ≤ 1 kΩ 1 kΩ < R ≤ 10 kΩ 10 kΩ < R ≤ 100 kΩ 100 kΩ < R ≤ 1 MΩ	max. 1 μV/V (0 dB) max. 3 μV/V (9.54 dB) max. 6 μV/V (15.56 dB) max. 10 μV/V (20 dB)
<b>Other applicable tests</b>				
		leaching	unmounted chips 60 ±1 s; 260 ±5 °C	good tinning; no leaching
	(JIS) C 5202 7.5	resistance to damp heat (steady state)	1000 +48/-0 hours; 40 ±2 °C; 93 +2/-3% RH; loaded with P <sub>n</sub> or V <sub>max</sub> ; 1.5 hours on, 0.5 hour off	ΔR/R max.: ±(2% + 0.1 Ω)

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**REVISION HISTORY**

Revision	Date	Change Notification	Description
Rev.2	2001 Apr 27	–	- Converted to Phycomp brand